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Interface formation between MgF₂ and Si(111) studied by LEED, AES, and TPD

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The phases and interface formation of MgF_2 on Si(111) were studied by using LEED, AES, and TPD. When thick MgF_2 film was deposited on the Si(111) surface at RT and annealed at higher temperatures, a sequence of LEED patterns (no LEED pattern $\rightarrow 1 \times 1 \rightarrow 3 \times 1 \rightarrow 7 \times 7$) was observed. On the 1×1 structure, both Mg and F bond to Si and the Mg:F ratio is almost equal to one. Upon annealing this surface at $600 \sim 800 \, ^{\circ}C$, a 3×1 reconstruction is obtained with liberating Mg and SiF_2 . The 1×1 model in which Mg adsorbs on T_4 site and F on H_3 site could explain the simultaneous desorption of SiF_2 and Mg.

When thin MgF₂ film was deposited, an initial α -1×1 phase transforms to 3×3 and β -1×1 by thermal annealing with a slow evaporation of F and diffusion of Mg into the surface. the 3×3 surface changes to γ -1×1 by the selective desorption of F under e-beam irradiation and subsesquently to a Mg-induced $\sqrt{3}$ structure by annealing at 600°C.